

RoHS

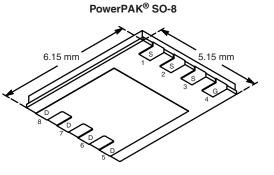
COMPLIANT

HALOGEN

Vishay Siliconix

## N-Channel 80 V (D-S) MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$R_{DS(on)}$ (Ω) $I_{D}$ (A) <sup>a</sup>		Q <sub>g</sub> (Typ.)	
80	0.0059 at V <sub>GS</sub> = 10 V	60		
	0.0067 at V <sub>GS</sub> = 7.5 V	60	23 nC	
	0.0085 at V <sub>GS</sub> = 4.5 V	60		



Bottom View

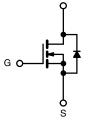
Ordering Information: SiR880DP-T1-GE3 (Lead (Pb)-free and Halogen-free)

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

- Fixed Telecom
- POL
- DC/DC Converter
- Primary Side Switch



N-Channel MOSFET

П

ABSOLUTE MAXIMUM RATINGS	<b>S</b> (T <sub>A</sub> = 25 °C, unle	ess otherwise no	ted)		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	80	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20	V	
	T <sub>C</sub> = 25 °C		60 <sup>a</sup>		
Continuous Drain Current ( $T_1 = 150 \ ^{\circ}C$ )	T <sub>C</sub> = 70 °C	L.	60 <sup>a</sup>		
Continuous Brain Current (1) = 150 C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	23 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		18.4 <sup>b, c</sup>	A	
Pulsed Drain Current		I <sub>DM</sub>	100	A	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	I <sub>S</sub>	60 <sup>a</sup>		
Commuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	'S	5.6 <sup>b, c</sup>		
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	35		
Single Pulse Avalanche Energy	L = 0.1 mm	E <sub>AS</sub>	61	mJ	
	T <sub>C</sub> = 25 °C		104		
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	PD	66.6	w	
	T <sub>A</sub> = 25 °C	'D	6.25 <sup>b, c</sup>	vv	
	T <sub>A</sub> = 70 °C		4.0 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	
Soldering Recommendations (Peak Temperature) <sup>d, e</sup>			260		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, f</sup>	t ≤ 10 s	R <sub>thJA</sub>	15	20	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub> 0.9 1.2		0/11		

Notes: a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. See solder profile (<u>www.vishay.com/ppg?73257</u>). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under steady state conditions is 54 °C/W.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	Cynisor			.,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	maxi	•	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	80			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$			36		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 5.8			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	1.2		2.8	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
	I <sub>DSS</sub>	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V			1	μΑ	
Zero Gate Voltage Drain Current		$V_{DS} = 80 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$			10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 V, V_{GS} = 10 V$	30			А	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A		0.0049	0.0059		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 7.5 V, I <sub>D</sub> = 20 A		0.0054	0.0067	Ω	
	DO(01)	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 15 A		0.0070	0.0085		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 20 A		64		S	
Dynamic <sup>b</sup>				1			
Input Capacitance	C <sub>iss</sub>		1	2440		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V, f = 1 MHz		1525			
Reverse Transfer Capacitance	C <sub>rss</sub>			100			
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A		49	74	nC	
		$V_{DS} = 40 \text{ V}, V_{GS} = 7.5 \text{ V}, I_D = 20 \text{ A}$		37.2	56		
				23	35		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		7.6			
Gate-Drain Charge	Q <sub>gd</sub>			9.2			
Gate Resistance	Rg	f = 1 MHz	0.4	2.1	4.2	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			12	24		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 40 V, $R_L$ = 2 $\Omega$		10	20	- ns	
Turn-Off Delay Time	t <sub>d(off)</sub> t <sub>f</sub>	$\text{I}_\text{D}\cong$ 20 A, $\text{V}_\text{GEN}$ = 10 V, $\text{R}_\text{g}$ = 1 $\Omega$		38	70		
Fall Time				11	22		
Turn-On Delay Time	t <sub>d(on)</sub>			15	30		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 40 V, $R_L$ = 2 $\Omega$		15	30		
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_\text{D}\cong$ 20 A, $\text{V}_\text{GEN}$ = 7.5 V, $\text{R}_\text{g}$ = 1 $\Omega$		37	70		
Fall Time	t <sub>f</sub>			9	18		
Drain-Source Body Diode Characteristic	s	-			•		
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			60	A	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				100		
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 5 A		0.75	1.1	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			56	100	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = 20 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		66	120	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$F = 20 \text{ A}, \text{ u/ut} = 100 \text{ A/}\mu\text{s}, \text{ f} \text{ J} = 20 \text{ C}$		23		ns	
Reverse Recovery Rise Time	t <sub>b</sub>			33			

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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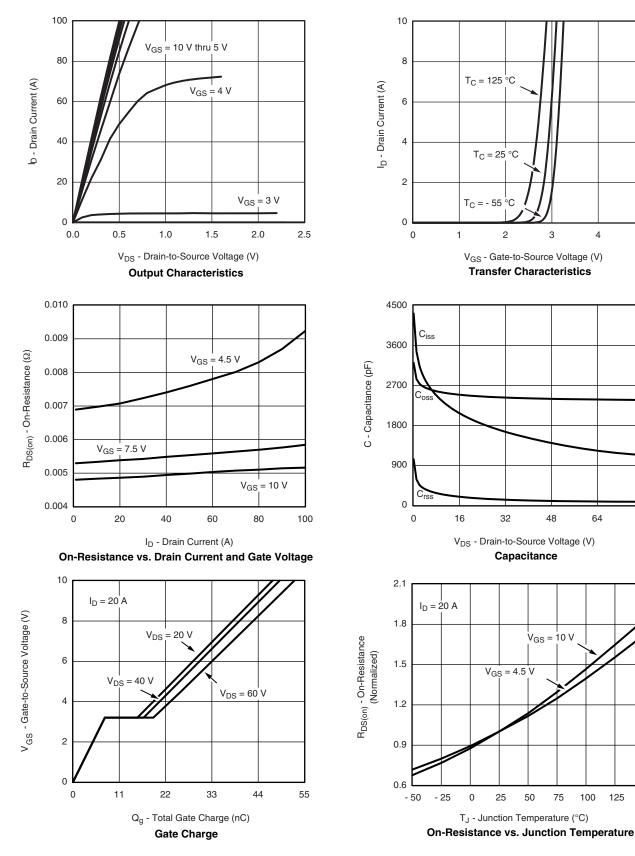
64

80

4

5

### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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125

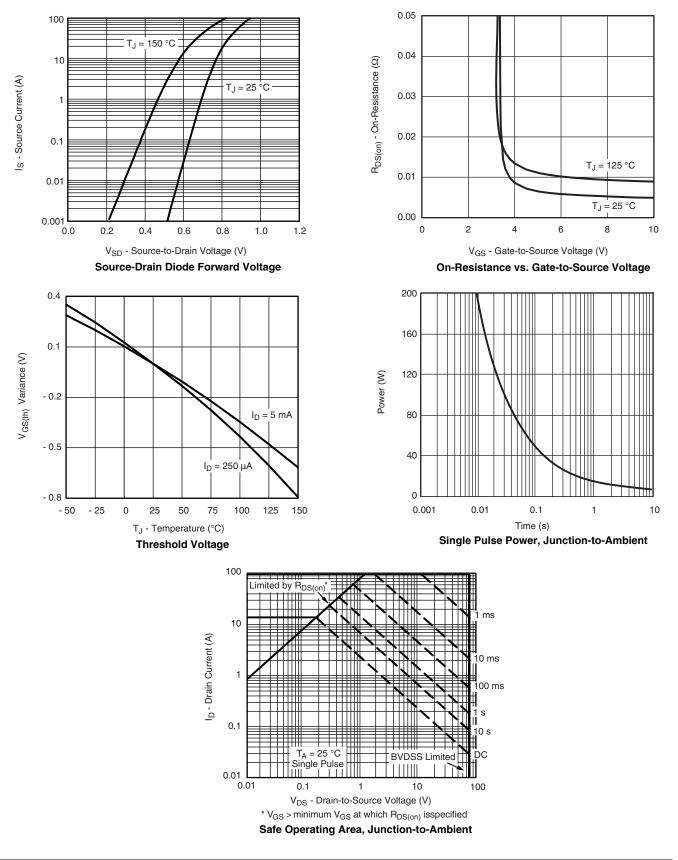
100

75

### **Vishay Siliconix**



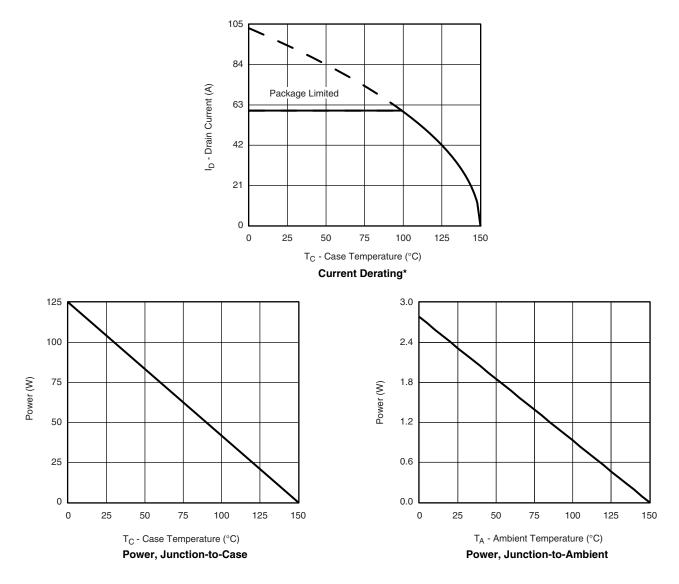
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





## SiR880DP Vishay Siliconix

#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

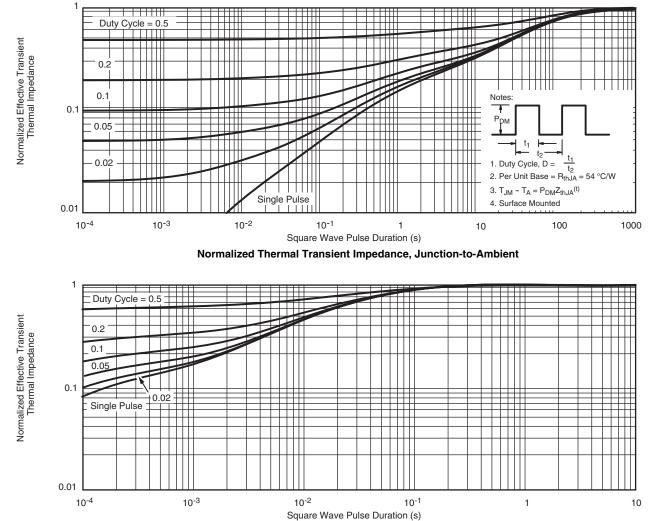


\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?65702</u>.

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